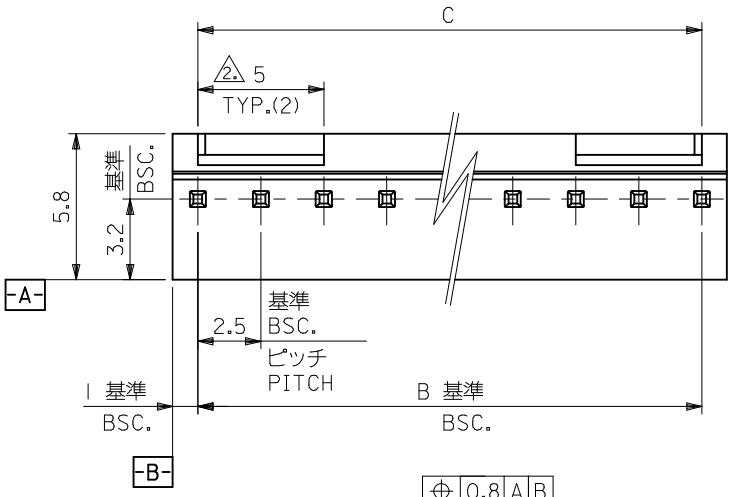
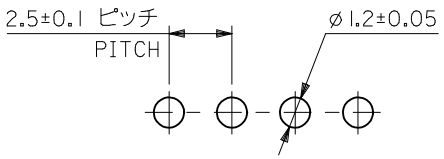
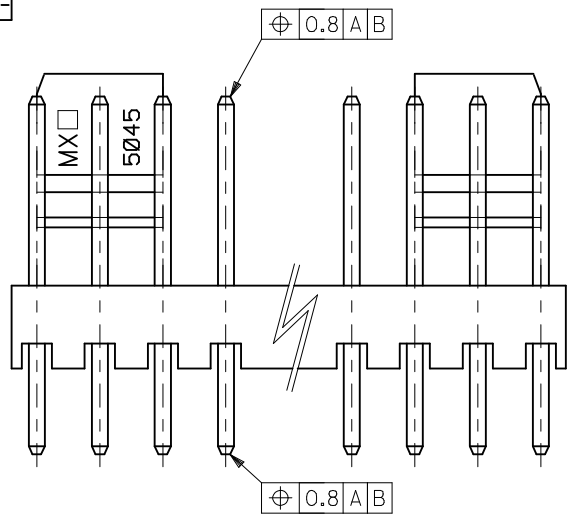
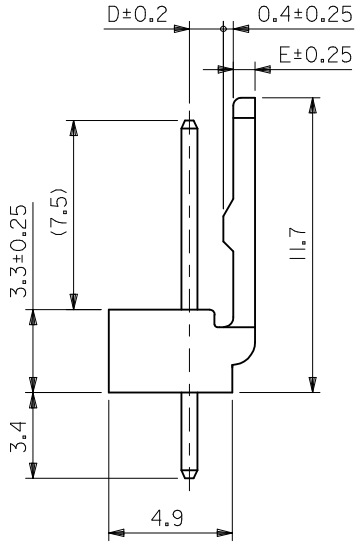


公差非累積
NON-ACCUMULATIVE



基板取付穴推奨寸法
RECOMMENDED P.C.BOARD HOLE DIM.





注)
NOTE.

1. 材料
MATERIAL
ピン　:□0.635×14.2 黄銅、銅下地錫メッキ
PIN: 0.635×14.2 BRASS TIN OVER COPPER PLATING.
ウェハー:ポリアミド,UL94V-0
WAFER: POLYAMIDE ,UL94V-0
2. 6極以上に適用
TO BE APPLIED FOR 6 CKT. AND MORE THEN 6 CKT.
3. 5極以下はロック部スリットなし
NO SLIT IS PROVIDED FOR 5 CKT. AND LESS THAN 5 CKT.
4. ELV 及び RoHS 適合品
ELV AND RoHS COMPLIANT

D	E	C	B	ORDER No.	極数 CKT.
1.35	0.85	47.5 +0.3 -0.45	47.5	22 04 1201	20
↑	↑	45 +0.3 -0.45	45	↑ 1191	19
		42.5 +0.3 -0.45	42.5	1181	18
		40 +0.3 -0.45	40	1171	17
		37.5 +0.3 -0.45	37.5	1161	16
		35 +0.3 -0.45	35	1151	15
		32.5 +0.25 -0.45	32.5	1141	14
		30 +0.25 -0.4	30	1131	13
		27.5 +0.25 -0.4	27.5	1121	12
		25 +0.2 -0.4	25	1111	11
		22.5 +0.2 -0.4	22.5	1101	10
		20 +0.15 -0.35	20	1091	9
		17.5 +0.15 -0.35	17.5	1081	8
		15 +0.1 -0.3	15	1071	7
		12.5 +0.1 -0.3	12.5	1061	6
↓	↓	10 +0.15 -0.3	10	1051	5
1.35	0.85	7.5 +0.15 -0.3	7.5	1041	4
1.2	1	5 +0.15 -0.3	5	↓ 1031	3
1.2	1	2.5 +0.15 -0.3	2.5	22 04 1021	2

MODEL No. : 5045-**A

REVICED
EC NO: J2012-0973 2012/01/30
DRWN:KWASHIO 2012/01/30
CH'KD:KASAKAWA 2013/06/13
APPR:NUKITA
DESCRIPTION
REV
L

GENERAL TOLERANCES (UNLESS SPECIFIED)

10 UNDER	±0.4
10 OVER 30 UNDER	±0.45
30 OVER	±0.5
ANGULAR	±3 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY	SCALE: 5:1	DESIGN UNITS: METRIC	THIRD ANGLE PROJECTION

DRAWN BY: K.KOHAMA DATE: 2000/03/28
CHECKED BY: T.YAMAGUCHI DATE: 2000/03/30
APPROVED BY: DATE

TITLE: KK 2.5 WAFER ASS'Y WITH LOCK

molex

MATERIAL NO.: SEE CHART
DOCUMENT NO.: SD-5045-NA
SHEET NO.: 1 OF 1
SIZE: A3

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